

Electronic Patent Application Fee Transmittal

Application Number:	10809076
Filing Date:	24-Mar-2004
Title of Invention:	SEMICONDUCTOR PROCESS FOR REMOVING DEFECTS DUE TO EDGE CHIPS OF A SEMICONDUCTOR WAFER AND SEMICONDUCTOR DEVICE FABRICATED THEREBY
First Named Inventor:	Jeong-Hun Park
Filer:	Alexander Charles Johnson/Li Mei Vermilya
Attorney Docket Number:	8750-062

Filed as Large Entity

Utility Filing Fees

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
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Basic Filing:

Pages:

Claims:

Miscellaneous-Filing:

Publ. Fee- early, voluntary, or normal	1504	1	300	300
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Petition:

Patent-Appeals-and-Interference:

Post-Allowance-and-Post-Issuance:

Utility Appl issue fee	1501	1	1400	1400
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Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Extension-of-Time:				
Miscellaneous:				
Total in USD (\$)				1700